

# PMEGxx05EH/EJ series

0.5 A very low  $V_F$  MEGA Schottky barrier rectifiers

Rev. 02 — 13 January 2010

Product data sheet

## 1. Product profile

### 1.1 General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection encapsulated in small SMD package.

Table 1. Product overview

| Type number | Package  |       | Configuration |
|-------------|----------|-------|---------------|
|             | Nexperia | JEITA |               |
| PMEG2005EH  | SOD123F  | -     | single diode  |
| PMEG3005EH  |          |       |               |
| PMEG4005EH  |          |       |               |
| PMEG2005EJ  | SOD323F  | SC-90 | single diode  |
| PMEG3005EJ  |          |       |               |
| PMEG4005EJ  |          |       |               |

### 1.2 Features

- Forward current: 0.5 A
- Very low forward voltage
- Flat lead SMD package

### 1.3 Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- Inverse polarity protection
- Low power consumption applications

## 1.4 Quick reference data

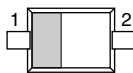
Table 2. Quick reference data

| Symbol | Parameter                 | Conditions                 | Min | Typ | Max | Unit |
|--------|---------------------------|----------------------------|-----|-----|-----|------|
| $I_F$  | forward current           | $T_{sp} \leq 55\text{ °C}$ | -   | -   | 0.5 | A    |
| $V_R$  | reverse voltage           |                            |     |     |     |      |
|        | PMEG2005EH,<br>PMEG2005EJ |                            | -   | -   | 20  | V    |
|        | PMEG3005EH,<br>PMEG3005EJ |                            | -   | -   | 30  | V    |
|        | PMEG4005EH,<br>PMEG4005EJ |                            | -   | -   | 40  | V    |
| $V_F$  | forward voltage           | $I_F = 500\text{ mA}$      | [1] |     |     |      |
|        | PMEG2005EH,<br>PMEG2005EJ |                            | -   | 355 | 390 | mV   |
|        | PMEG3005EH,<br>PMEG3005EJ |                            | -   | 380 | 430 | mV   |
|        | PMEG4005EH,<br>PMEG4005EJ |                            | -   | 420 | 470 | mV   |

[1] Pulse test:  $t_p \leq 300\text{ }\mu\text{s}$ ;  $\delta \leq 0.02$ .

## 2. Pinning information

Table 3. Pinning

| Pin | Description | Simplified outline                                                                    | Symbol                                                                                          |
|-----|-------------|---------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------|
| 1   | cathode     |  | <br>sym001 |
| 2   | anode       |                                                                                       |                                                                                                 |

[1] The marking bar indicates the cathode.

## 3. Ordering information

Table 4. Ordering information

| Type number | Package |                                          |         |
|-------------|---------|------------------------------------------|---------|
|             | Name    | Description                              | Version |
| PMEG2005EH  | -       | plastic surface mounted package; 2 leads | SOD123F |
| PMEG3005EH  |         |                                          |         |
| PMEG4005EH  |         |                                          |         |
| PMEG2005EJ  | SC-90   | plastic surface mounted package; 2 leads | SOD323F |
| PMEG3005EJ  |         |                                          |         |
| PMEG4005EJ  |         |                                          |         |

## 4. Marking

Table 5. Marking codes

| Type number | Marking code |
|-------------|--------------|
| PMEG2005EH  | A3           |
| PMEG3005EH  | A4           |
| PMEG4005EH  | A5           |
| PMEG2005EJ  | CC           |
| PMEG3005EJ  | CD           |
| PMEG4005EJ  | CE           |

## 5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol    | Parameter                           | Conditions                                  | Min   | Max  | Unit |
|-----------|-------------------------------------|---------------------------------------------|-------|------|------|
| $V_R$     | reverse voltage                     |                                             |       |      |      |
|           | PMEG2005EH,<br>PMEG2005EJ           |                                             | -     | 20   | V    |
|           | PMEG3005EH,<br>PMEG3005EJ           |                                             | -     | 30   | V    |
|           | PMEG4005EH,<br>PMEG4005EJ           |                                             | -     | 40   | V    |
| $I_F$     | forward current                     | $T_{sp} \leq 55\text{ °C}$                  | -     | 0.5  | A    |
| $I_{FRM}$ | repetitive peak forward current     | $t_p \leq 1\text{ ms}$ ; $\delta \leq 0.25$ | -     | 7    | A    |
| $I_{FSM}$ | non-repetitive peak forward current | $t = 8\text{ ms}$ square wave               | -     | 10   | A    |
| $P_{tot}$ | total power dissipation             | $T_{amb} \leq 25\text{ °C}$                 |       |      |      |
|           | SOD123F                             |                                             | [1] - | 375  | mW   |
|           |                                     |                                             | [2] - | 830  | mW   |
|           | SOD323F                             |                                             | [1] - | 360  | mW   |
|           |                                     |                                             | [2] - | 830  | mW   |
| $T_j$     | junction temperature                |                                             | -     | 150  | °C   |
| $T_{amb}$ | ambient temperature                 |                                             | -65   | +150 | °C   |
| $T_{stg}$ | storage temperature                 |                                             | -65   | +150 | °C   |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

## 6. Thermal characteristics

**Table 7. Thermal characteristics**

| Symbol         | Parameter                                        | Conditions  | Min                                     | Typ | Max | Unit |
|----------------|--------------------------------------------------|-------------|-----------------------------------------|-----|-----|------|
| $R_{th(j-a)}$  | thermal resistance from junction to ambient      | in free air | <a href="#">[1]</a> <a href="#">[2]</a> |     |     |      |
|                | SOD123F                                          |             | -                                       | -   | 330 | K/W  |
|                | SOD323F                                          |             | -                                       | -   | 350 | K/W  |
|                |                                                  |             | <a href="#">[1]</a> <a href="#">[3]</a> | -   | 150 | K/W  |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point |             |                                         |     |     |      |
|                | SOD123F                                          |             | -                                       | -   | 60  | K/W  |
|                | SOD323F                                          |             | -                                       | -   | 55  | K/W  |

[1] Schottky barrier diodes thermal run-away has to be considered, as in some applications the reverse power losses  $P_R$  are a significant part of the total power losses. Nomograms for determining the reverse power losses  $P_R$  and  $I_{F(AV)}$  rating will be available on request.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

## 7. Characteristics

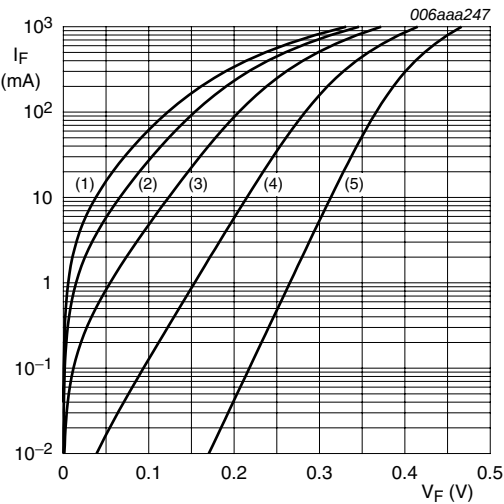
**Table 8. Characteristics**

$T_{amb} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified.

| Symbol | Parameter                 | Conditions            | Min                                  | Typ | Max | Unit          |
|--------|---------------------------|-----------------------|--------------------------------------|-----|-----|---------------|
| $V_F$  | forward voltage           |                       | [1]                                  |     |     |               |
|        | PMEG2005EH,<br>PMEG2005EJ | $I_F = 0.1\text{ mA}$ | -                                    | 90  | 130 | mV            |
|        |                           | $I_F = 1\text{ mA}$   | -                                    | 150 | 190 | mV            |
|        |                           | $I_F = 10\text{ mA}$  | -                                    | 210 | 240 | mV            |
|        |                           | $I_F = 100\text{ mA}$ | -                                    | 280 | 330 | mV            |
|        |                           | $I_F = 500\text{ mA}$ | -                                    | 355 | 390 | mV            |
|        | PMEG3005EH,<br>PMEG3005EJ | $I_F = 0.1\text{ mA}$ | -                                    | 90  | 130 | mV            |
|        |                           | $I_F = 1\text{ mA}$   | -                                    | 150 | 200 | mV            |
|        |                           | $I_F = 10\text{ mA}$  | -                                    | 215 | 250 | mV            |
|        |                           | $I_F = 100\text{ mA}$ | -                                    | 285 | 340 | mV            |
|        |                           | $I_F = 500\text{ mA}$ | -                                    | 380 | 430 | mV            |
|        | PMEG4005EH,<br>PMEG4005EJ | $I_F = 0.1\text{ mA}$ | -                                    | 95  | 130 | mV            |
|        |                           | $I_F = 1\text{ mA}$   | -                                    | 155 | 210 | mV            |
|        |                           | $I_F = 10\text{ mA}$  | -                                    | 220 | 270 | mV            |
|        |                           | $I_F = 100\text{ mA}$ | -                                    | 295 | 350 | mV            |
|        |                           | $I_F = 500\text{ mA}$ | -                                    | 420 | 470 | mV            |
| $I_R$  | reverse current           |                       | [1][2]                               |     |     |               |
|        | PMEG2005EH,<br>PMEG2005EJ | $V_R = 10\text{ V}$   | -                                    | 15  | 40  | $\mu\text{A}$ |
|        |                           | $V_R = 20\text{ V}$   | -                                    | 40  | 200 | $\mu\text{A}$ |
|        | PMEG3005EH,<br>PMEG3005EJ | $V_R = 10\text{ V}$   | -                                    | 12  | 30  | $\mu\text{A}$ |
|        |                           | $V_R = 30\text{ V}$   | -                                    | 40  | 150 | $\mu\text{A}$ |
|        | PMEG4005EH,<br>PMEG4005EJ | $V_R = 10\text{ V}$   | -                                    | 7   | 20  | $\mu\text{A}$ |
|        |                           | $V_R = 40\text{ V}$   | -                                    | 30  | 100 | $\mu\text{A}$ |
| $C_d$  | diode capacitance         |                       | $V_R = 1\text{ V}; f = 1\text{ MHz}$ |     |     |               |
|        | PMEG2005EH,<br>PMEG2005EJ |                       | -                                    | 66  | 80  | pF            |
|        | PMEG3005EH,<br>PMEG3005EJ |                       | -                                    | 55  | 70  | pF            |
|        | PMEG4005EH,<br>PMEG4005EJ |                       | -                                    | 43  | 50  | pF            |

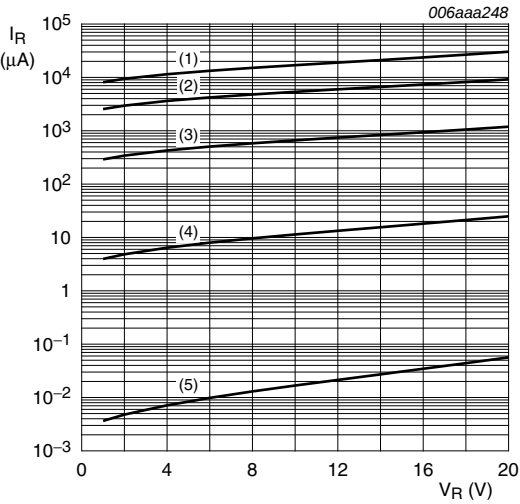
[1] Pulse test:  $t_p \leq 300\text{ }\mu\text{s}$ ;  $\delta \leq 0.02$ .

[2] Schottky barrier rectifier thermal run-away has to be considered, as in some applications the reverse power losses  $P_R$  are a significant part of the total power losses. Nomograms for determining the reverse power losses  $P_R$  and  $I_{F(AV)}$  rating will be available on request.



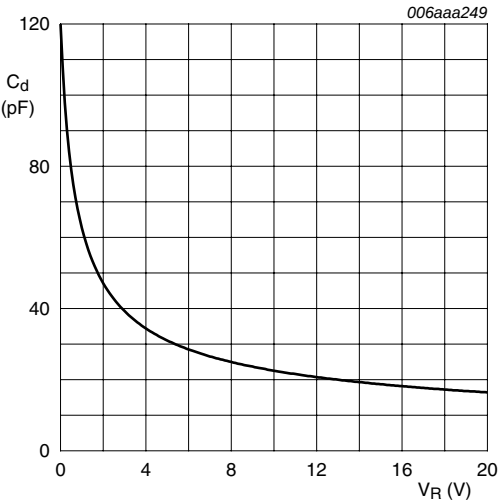
- (1)  $T_{amb} = 150\text{ °C}$
- (2)  $T_{amb} = 125\text{ °C}$
- (3)  $T_{amb} = 85\text{ °C}$
- (4)  $T_{amb} = 25\text{ °C}$
- (5)  $T_{amb} = -40\text{ °C}$

Fig 1. PMEG2005EH, PMEG2005EJ: Forward current as a function of forward voltage; typical values



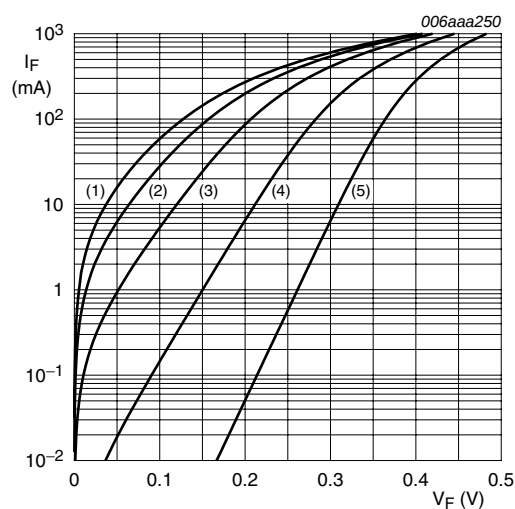
- (1)  $T_{amb} = 150\text{ °C}$
- (2)  $T_{amb} = 125\text{ °C}$
- (3)  $T_{amb} = 85\text{ °C}$
- (4)  $T_{amb} = 25\text{ °C}$
- (5)  $T_{amb} = -40\text{ °C}$

Fig 2. PMEG2005EH, PMEG2005EJ: Reverse current as a function of reverse voltage; typical values



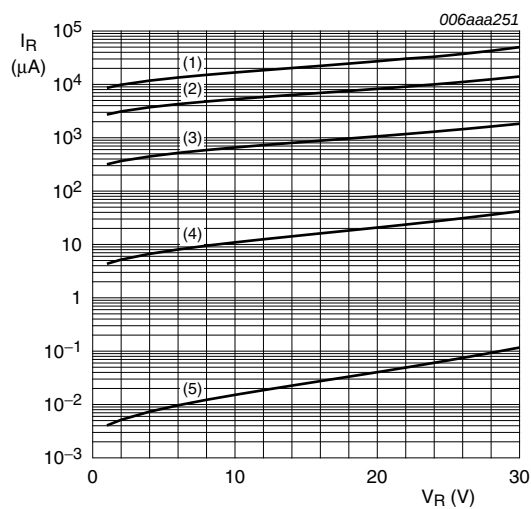
$T_{amb} = 25\text{ °C}$ ;  $f = 1\text{ MHz}$

Fig 3. PMEG2005EH, PMEG2005EJ: Diode capacitance as a function of reverse voltage; typical values



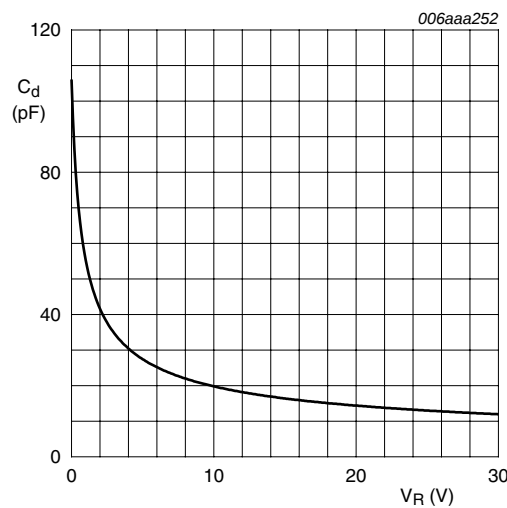
- (1)  $T_{amb} = 150\text{ °C}$
- (2)  $T_{amb} = 125\text{ °C}$
- (3)  $T_{amb} = 85\text{ °C}$
- (4)  $T_{amb} = 25\text{ °C}$
- (5)  $T_{amb} = -40\text{ °C}$

Fig 4. PMEG3005EH, PMEG3005EJ: Forward current as a function of forward voltage; typical values



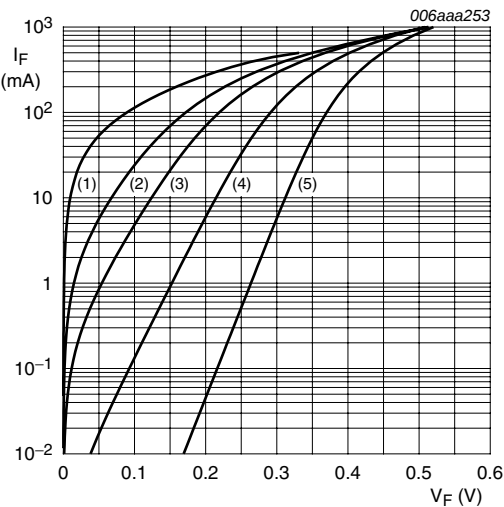
- (1)  $T_{amb} = 150\text{ °C}$
- (2)  $T_{amb} = 125\text{ °C}$
- (3)  $T_{amb} = 85\text{ °C}$
- (4)  $T_{amb} = 25\text{ °C}$
- (5)  $T_{amb} = -40\text{ °C}$

Fig 5. PMEG3005EH, PMEG3005EJ: Reverse current as a function of reverse voltage; typical values



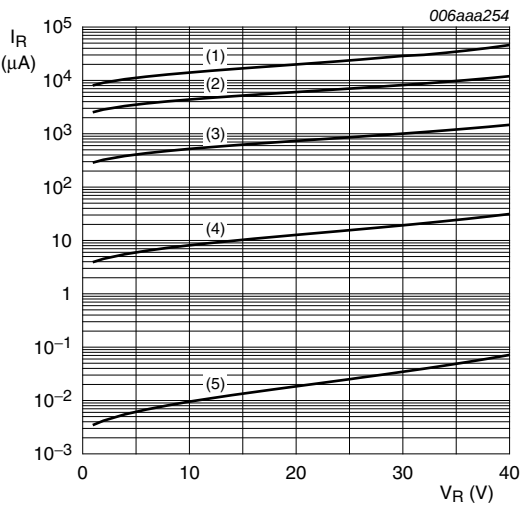
$T_{amb} = 25\text{ °C}$ ;  $f = 1\text{ MHz}$

Fig 6. PMEG3005EH, PMEG3005EJ: Diode capacitance as a function of reverse voltage; typical values



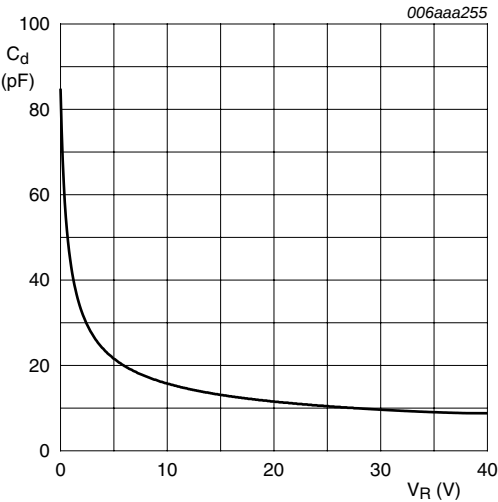
- (1)  $T_{amb} = 150\text{ °C}$
- (2)  $T_{amb} = 125\text{ °C}$
- (3)  $T_{amb} = 85\text{ °C}$
- (4)  $T_{amb} = 25\text{ °C}$
- (5)  $T_{amb} = -40\text{ °C}$

Fig 7. PMEG4005EH, PMEG4005EJ: Forward current as a function of forward voltage; typical values



- (1)  $T_{amb} = 150\text{ °C}$
- (2)  $T_{amb} = 125\text{ °C}$
- (3)  $T_{amb} = 85\text{ °C}$
- (4)  $T_{amb} = 25\text{ °C}$
- (5)  $T_{amb} = -40\text{ °C}$

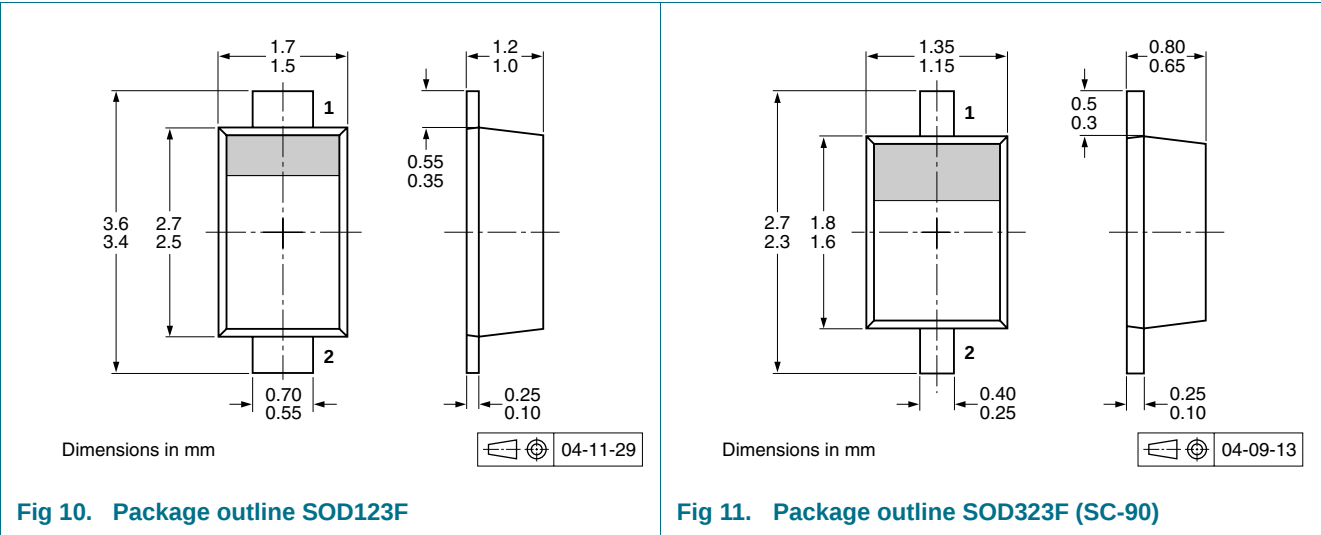
Fig 8. PMEG4005EH, PMEG4005EJ: Reverse current as a function of reverse voltage; typical values



$T_{amb} = 25\text{ °C}$ ;  $f = 1\text{ MHz}$

Fig 9. PMEG4005EH, PMEG4005EJ: Diode capacitance as a function of reverse voltage; typical values

8. Package outline



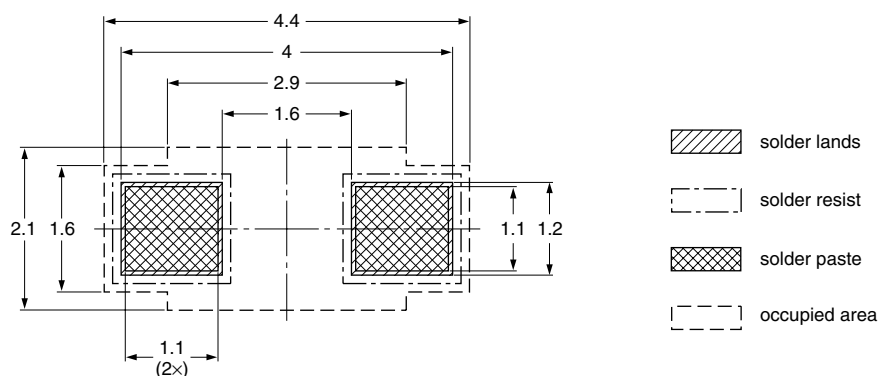
9. Packing information

Table 9. Packing methods  
The indicated -xxx are the last three digits of the 12NC ordering code.<sup>[1]</sup>

| Type number | Package | Description                    | Packing quantity |       |
|-------------|---------|--------------------------------|------------------|-------|
|             |         |                                | 3000             | 10000 |
| PMEG2005EH  | SOD123F | 4 mm pitch, 8 mm tape and reel | -115             | -135  |
| PMEG3005EH  |         |                                |                  |       |
| PMEG4005EH  |         |                                |                  |       |
| PMEG2005EJ  | SOD323F | 4 mm pitch, 8 mm tape and reel | -115             | -135  |
| PMEG3005EJ  |         |                                |                  |       |
| PMEG4005EJ  |         |                                |                  |       |

[1] For further information and the availability of packing methods, see [Section 13](#).

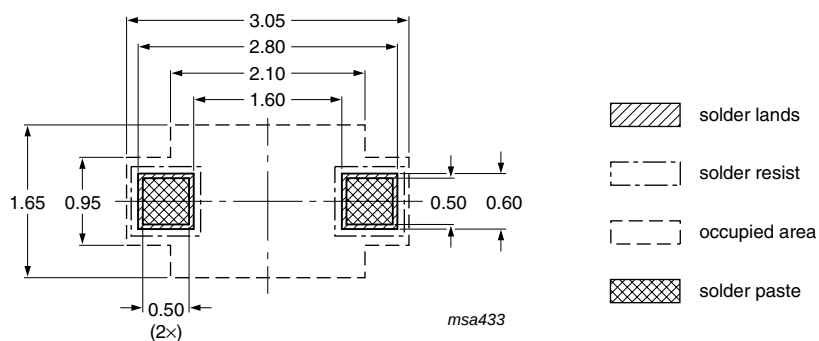
## 10. Soldering



Reflow soldering is the only recommended soldering method.

Dimensions in mm

**Fig 12. Reflow soldering footprint SOD123F**



Reflow soldering is the only recommended soldering method.

Dimensions in mm

**Fig 13. Reflow soldering footprint SOD323F (SC-90)**

## 11. Revision history

Table 10. Revision history

| Document ID                                                                                                                                                                                                                     | Release date | Data sheet status  | Change notice | Supersedes          |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------|--------------------|---------------|---------------------|
| PMEGXX05EH_EJ_SER_2                                                                                                                                                                                                             | 20100113     | Product data sheet | -             | PMEGXX05EH_EJ_SER_1 |
| Modifications:                                                                                                                                                                                                                  |              |                    |               |                     |
| <ul style="list-style-type: none"><li>This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content.</li></ul> |              |                    |               |                     |
| PMEGXX05EH_EJ_SER_1                                                                                                                                                                                                             | 20050412     | Product data sheet | -             | -                   |

## 12. Legal information

### 12.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition                                                                            |
|-----------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

### 12.2 Definitions

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Nexperia does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

**Short data sheet** — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Nexperia sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

### 12.3 Disclaimers

**General** — Information in this document is believed to be accurate and reliable. However, Nexperia does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

**Right to make changes** — Nexperia reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

**Suitability for use** — Nexperia products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of a Nexperia product can reasonably be expected to result in personal injury, death or severe property or environmental

damage. Nexperia accepts no liability for inclusion and/or use of Nexperia products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. Nexperia makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

**Limiting values** — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

**Terms and conditions of sale** — Nexperia products are sold subject to the general terms and conditions of commercial sale, as published at <http://www.nexperia.com/profile/terms>, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by Nexperia. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

### 12.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

## 13. Contact information

For more information, please visit: <http://www.nexperia.com>

For sales office addresses, please send an email to: [salesaddresses@nexperia.com](mailto:salesaddresses@nexperia.com)

## 14. Contents

---

|           |                                          |           |
|-----------|------------------------------------------|-----------|
| <b>1</b>  | <b>Product profile</b> . . . . .         | <b>1</b>  |
| 1.1       | General description . . . . .            | 1         |
| 1.2       | Features . . . . .                       | 1         |
| 1.3       | Applications . . . . .                   | 1         |
| 1.4       | Quick reference data . . . . .           | 2         |
| <b>2</b>  | <b>Pinning information</b> . . . . .     | <b>2</b>  |
| <b>3</b>  | <b>Ordering information</b> . . . . .    | <b>2</b>  |
| <b>4</b>  | <b>Marking</b> . . . . .                 | <b>3</b>  |
| <b>5</b>  | <b>Limiting values</b> . . . . .         | <b>3</b>  |
| <b>6</b>  | <b>Thermal characteristics</b> . . . . . | <b>4</b>  |
| <b>7</b>  | <b>Characteristics</b> . . . . .         | <b>5</b>  |
| <b>8</b>  | <b>Package outline</b> . . . . .         | <b>9</b>  |
| <b>9</b>  | <b>Packing information</b> . . . . .     | <b>9</b>  |
| <b>10</b> | <b>Soldering</b> . . . . .               | <b>10</b> |
| <b>11</b> | <b>Revision history</b> . . . . .        | <b>11</b> |
| <b>12</b> | <b>Legal information</b> . . . . .       | <b>12</b> |
| 12.1      | Data sheet status . . . . .              | 12        |
| 12.2      | Definitions . . . . .                    | 12        |
| 12.3      | Disclaimers . . . . .                    | 12        |
| 12.4      | Trademarks . . . . .                     | 12        |
| <b>13</b> | <b>Contact information</b> . . . . .     | <b>12</b> |
| <b>14</b> | <b>Contents</b> . . . . .                | <b>13</b> |